TENTATIVE

TOSHIBA PHOTOCOUPLER GaAlAs IRED & PHOTO-DIODE ARRAY

TLP191B

TELECOMMUNICATION
PROGRAMMABLE CONTROLLERS
MOS GATE DRIVER
MOS FET GATE DRIVER

The TOSHIBA MINI FLAT COUPLER TLP191B is a small outline coupler, suitable for surface mount assembly.

The TLP191B consists of a GaAlAs light emitting diode, optically coupled to a series connected photo diode array with shunt resistor which is suitable for MOS FET gate drive.

Open Voltage : 7.0V (MIN.)
 Short Current : 24.0 \(\mu \text{A} \) (MIN.)

• Isolation Voltage: 2500Vrms (MIN.)

• UL Recognized : UL1577, File No. E67349

MAXIMUM RATINGS (Ta = 25°C)

СН	ARACTERISTIC	SYMBOL	RATING	UNIT	
LED	Forward Current	$I_{\mathbf{F}}$	50	mA	
	Forward Current Derating (Ta≥25°C)	⊿I _F /°C	-0.5	mA/°C	
	Pulse Forward Current (100 µs pulse 100 pps)	$I_{ extbf{FP}}$	1	A	
	Reverse Voltage	$v_{ m R}$	3	V	
	Junction Temperature	$\mathrm{T_{j}}$	125	°C	
	Forward Current	$I_{ m FD}$	50	μ A	
DETECTOR	Reverse Voltage	$ m v_{RD}$	10	V	
	Junction Temperature	$\mathrm{T_{j}}$	125	°C	
Storage Tem	perature Range	$\mathrm{T}_{\mathrm{stg}}$	-55~125	°C	
Operating T	emperature Range	T _{opr} -40~8		°C	
Lead Solderi	ing Temperature (10s)	T_{sol}	260	°C	
Isolation Vo. (AC, 1 min.,	ltage R.H.≤60%) (Note)	$BV_{\mathbf{S}}$	2500	Vrms	

Unit in mm

6 4

7 7 0 ± 0.4

1 3

3.6 ± 0.2

0.4

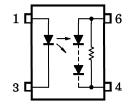
0.5 MIN.

11-4C1

TOSHIBA 11-4C1

Weight: 0.09g

PIN CONFIGURATION (TOP VIEW)



- 1. ANODE
- 3. CATHODE
- 4. CATHODE
- 6. ANODE

(Note) Device considered a two terminal device: Pins 1 and 3 shorted together and Pins 4 and 6 shorted together.

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RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward Current	$I_{\mathbf{F}}$	_	20	25	mA
Operating Temperature	$T_{ m opr}$	-25	_	85	°C

INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	$ m V_{f F}$	I _F =10mA	1.2	1.4	1.7	V
	Reverse Current	${ m I}_{ m R}$	$V_R=3V$	_		10	μ A
	Capacitance	C_{T}	V=0, f=1MHz	_	30	60	рF
DETECTOR	Forward Voltage	$v_{ m FD}$	$I_{\text{FD}} = 10 \mu \text{A}$	_	7	_	V
	Reverse Current	$I_{ m RD}$	$V_{RD} = 10V$	_	7	—	μ A
	Capacitance (Anode to Cathode)	C_{TD}	V=0, f=1MHz	_	_	_	pF

COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Open Voltage	v_{oc}	$I_{\mathbf{F}} = 20 \text{mA}$	7	8	_	V
Short Current	I_{SC}	$I_F = 20 \text{mA}$	24	40	_	μ A

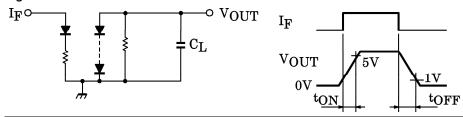
ISOLATION CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	c_{S}	$V_S=0$, f=1MHz		0.8	_	рF
Isolation Resistance	$R_{\mathbf{S}}$	$V_{S} = 500V, R.H. \le 60\%$	5×10^{10}	10^{14}	_	Ω
Isolation Voltage	$BV_{\mathbf{S}}$	AC, 1 minute	2500		_	1 7
		AC, 1 second in oil	_	5000	_	Vrms
		DC, 1 minute in oil	_	5000	_	Vdc

SWITCHING CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Turn-on Time	$t_{ m ON}$	$I_{\rm F} = 20 { m mA}, \ C_{\rm L} = 1000 { m pF}$	_	0.2	_	ms
Turn-off Time	tOFF	(Fig.1)	_	3	_	ms

Fig.1 SWITCHING TIME TEST CIRCUIT



Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

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